



SKJERVEN
MORRILL
MACPHERSON LLP

11-13-00

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Docket No.: AB-1060 US

November 10, 2000

BOX PATENT APPLICATION
COMMISSIONER FOR PATENTS
WASHINGTON, D. C. 20231

Enclosed herewith for filing is a patent application, as follows:

Inventor: Lee, Jong-Myoung

Title: Lead On Chip Type Semiconductor Package

- ☒ Return Receipt Postcard
- ☒ This Transmittal Letter (in duplicate)
- 8 Pages Specification (not including claims)
- 2 Pages Claims
- 1 Page Abstract
- 3 Sheets of Drawings (Figs. 1, 2, 3, 4, 5, 6, and 7)
- 2 Pages Declaration For Patent Application and Power of Attorney
- 1 Page Recordation Form Cover Sheet (in duplicate)
- 1 Page Assignment
- 1 Page PTO Form 1449 citing 5 references
- ☒ Copies of 5 Cited References submitted
- ☒ Other: Certified Copy of Korean Application No.: 99-49675, filed on November 10, 1999

CLAIMS AS FILED

For	Number Filed			Number Extra		Rate		Basic Fee
Total Claims	7	-20	=	0	x	\$ 18.00	=	\$ 710.00
Independent Claims	2	-3	=	0	x	\$80	=	\$ 0.00
<input type="checkbox"/>	Fee of _____ for the first filing of one or more multiple dependent claims per application							\$
<input type="checkbox"/>	Fee for Request for Extension of Time							\$

Please make the following charges to Deposit Account 19-2386:

- ☒ Total fee for filing the patent application in the amount of \$ 710.00
- ☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account 19-2386.

EXPRESS MAIL LABEL NO:

EL 701 023 554 US

Respectfully submitted,

David T. Millers

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